



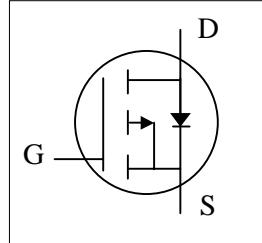
**Advanced Power  
Electronics Corp.**

**AP6679BGI-HF**

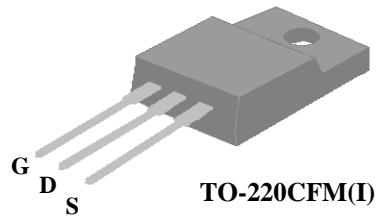
**Halogen-Free Product**

**P-CHANNEL ENHANCEMENT MODE  
POWER MOSFET**

- ▼ Low On-resistance
- ▼ Simple Drive Requirement
- ▼ Fast Switching Characteristic
- ▼ RoHS Compliant & Halogen-Free



$BV_{DSS}$	-30V
$R_{DS(ON)}$	9mΩ
$I_D$	-48A



## Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220CFM isolation package is widely preferred for all commercial-industrial through hole applications.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-30	V
$V_{GS}$	Gate-Source Voltage	+20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	-48	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	-30	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	-200	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	31.3	W
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	1.92	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Value	Units
$R_{thj-c}$	Maximum Thermal Resistance Junction-case	4	°C/W
$R_{thj-a}$	Maximum Thermal Resistance, Junction-ambient	65	°C/W



### Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=-10V, I_D=-30A$	-	-	9	$m\Omega$
		$V_{GS}=-4.5V, I_D=-20A$	-	-	15	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-	-3	V
$g_{fs}$	Forward Transconductance	$V_{DS}=-10V, I_D=-30A$	-	60	-	S
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=-24V, V_{GS}=0V$	-	-	-10	$\mu A$
$I_{GSS}$	Gate-Source Leakage	$V_{GS}= \pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
$Q_g$	Total Gate Charge	$I_D=-30A$	-	44	70	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=-24V$	-	6.5	-	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=-4.5V$	-	28.5	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=-15V$	-	11	-	ns
$t_r$	Rise Time	$I_D=-30A$	-	67	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=1\Omega$	-	37	-	ns
$t_f$	Fall Time	$V_{GS}=-10V$	-	22	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	3500	5600	pF
$C_{oss}$	Output Capacitance	$V_{DS}=-25V$	-	520	-	pF
$C_{rss}$	Reverse Transfer Capacitance	f=1.0MHz	-	495	-	pF
$R_g$	Gate Resistance	f=1.0MHz	-	2	4	$\Omega$

### Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{SD}$	Forward On Voltage <sup>2</sup>	$I_S=-30A, V_{GS}=0V$	-	-	-1.2	V
$t_{rr}$	Reverse Recovery Time	$I_S=-10A, V_{GS}=0V,$ $dI/dt=100A/\mu s$	-	34	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	30	-	nC

### Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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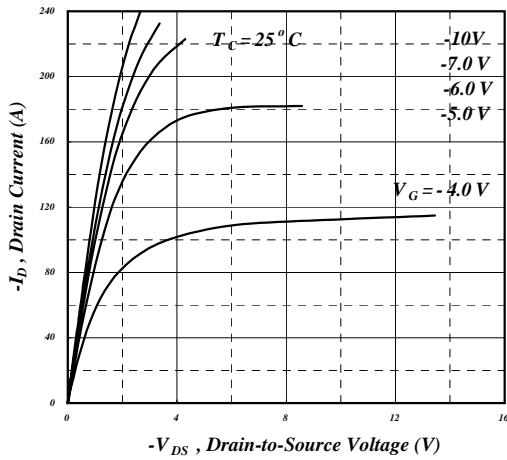


Fig 1. Typical Output Characteristics

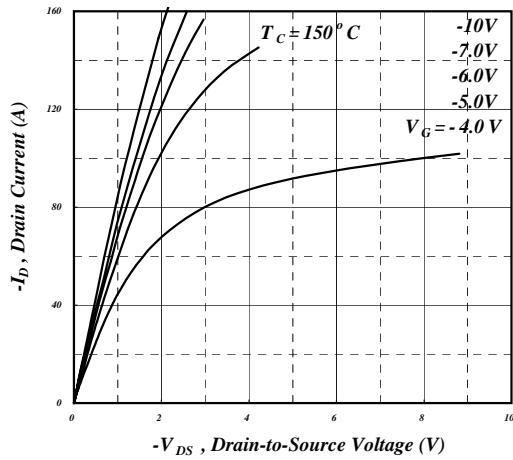


Fig 2. Typical Output Characteristics

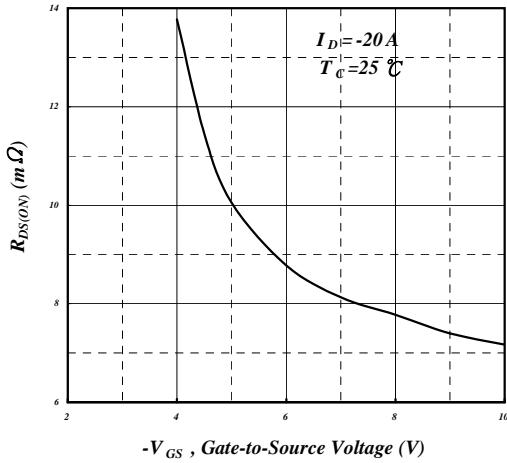


Fig 3. On-Resistance v.s. Gate Voltage

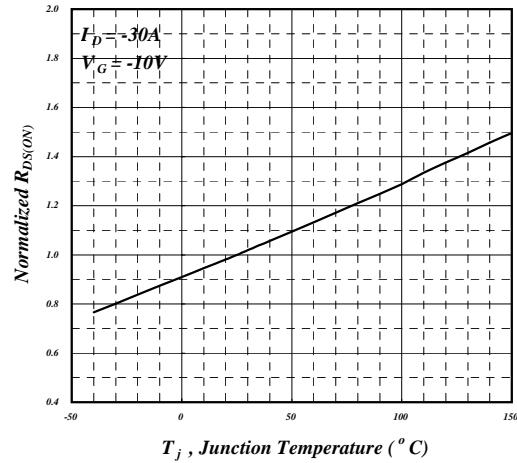


Fig 4. Normalized On-Resistance v.s. Junction Temperature

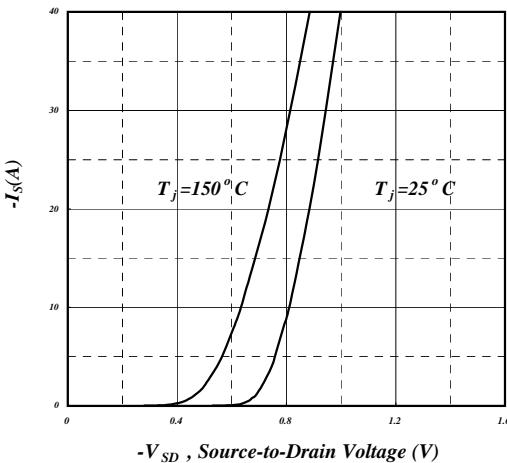


Fig 5. Forward Characteristic of Reverse Diode

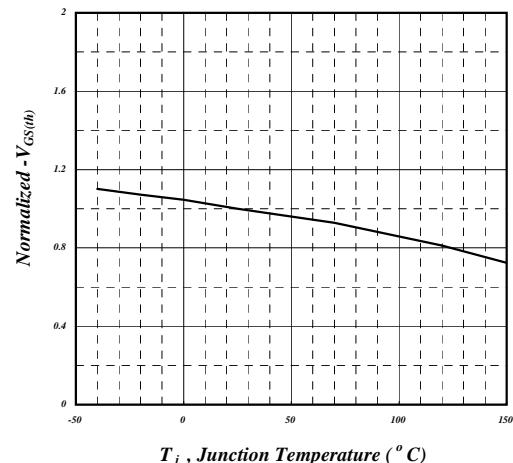
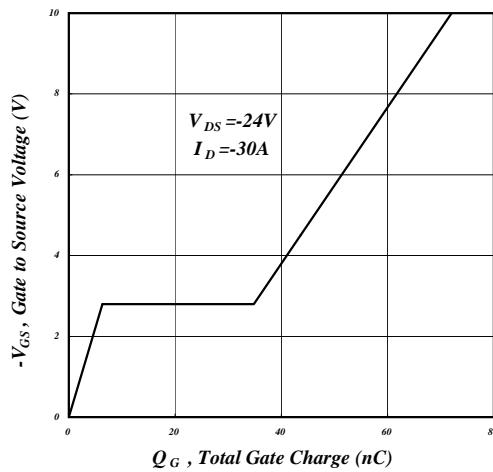
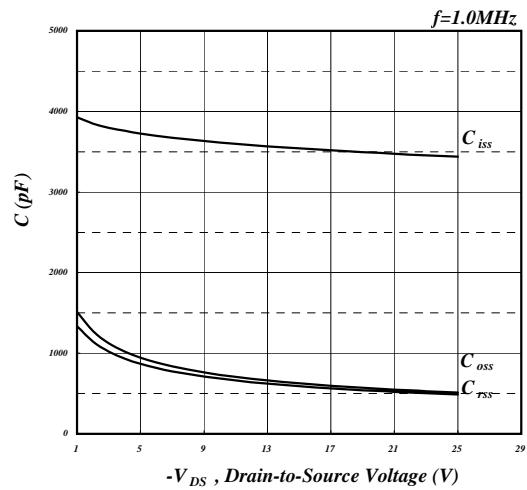


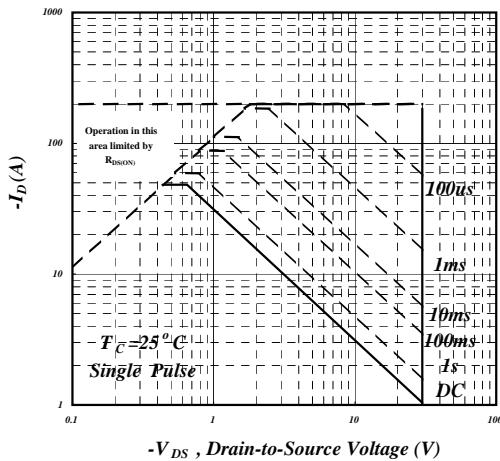
Fig 6. Gate Threshold Voltage v.s. Junction Temperature



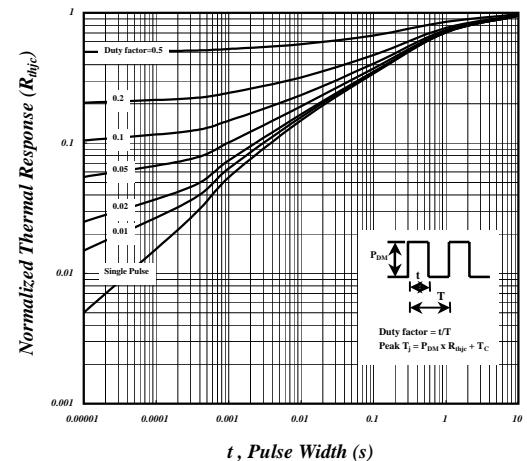
**Fig 7. Gate Charge Characteristics**



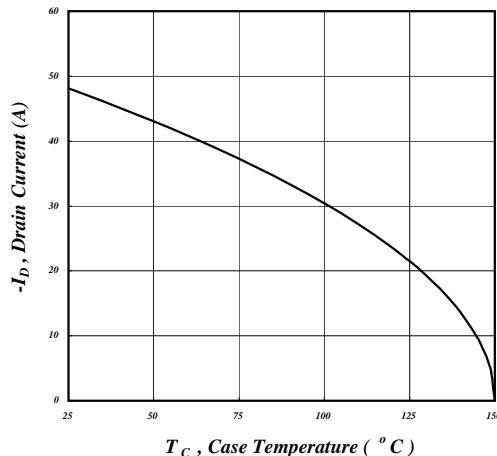
**Fig 8. Typical Capacitance Characteristics**



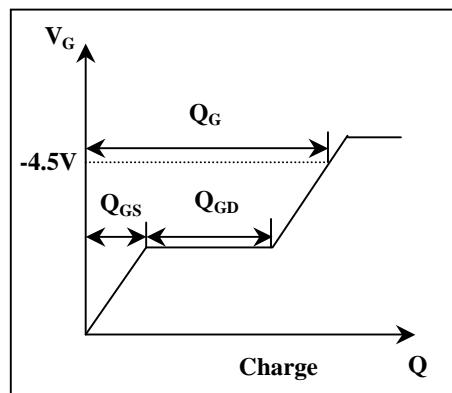
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**



**Fig 11. Maximum Continuous Drain Current v.s. Case Temperature**



**Fig 12. Gate Charge Waveform**